



RoHS Compliant

**MAX
260°C**

**MSL
1**



PRODUCT FAMILY	Material	CAS Number	% Normalize for BOM	Wt. Of BOM Item (g)	% by Wt (Comp. Item)	mg/unit	% by Wt Of Unit 90.70	ppm
753 8 SRT	Alumina Ceramic	Al2O3	0.8800	0.0798	87.50%	69.8390	77.00%	770000
		SiO2 (silicon dioxide)	14808-60-7		12.50%	9.9770	11.00%	110000
					100.00%	79.8160		
	Conductor Thick Film	Ag	0.0068	0.0006	100.00%	0.6168	0.68%	6800
					100.00%	0.6168		
	Resistor Thick Film	RuO2	0.0079	0.0007	30.00%	0.2150	0.24%	2370
		PbO	1317-36-8		10.00%	0.0717	0.08%	790
		SiO2 (silicon dioxide)	14808-60-7		30.00%	0.2150	0.24%	2370
		B2O3	1303-86-2		30.00%	0.2150	0.24%	2370
					100.00%	0.7165		
	Notch Conductor Thick Film	Ag	0.0113	0.0010	100.00%	1.0249	1.13%	11300
					100.00%	1.0249		
	Underplate	Ni	0.0250	0.0023	100.00%	2.2675	2.50%	25000
					100.00%	2.2675		
	Finish Plate	Sn	0.0170	0.0015	100.00%	1.5419	1.70%	17000
					100.00%	1.5419		
	Covercoat	TiO2	0.0520	0.0047	50.00%	2.3582	2.60%	26000
		Silicone	218163-11-2		50.00%	2.3582	2.60%	26000
		Sum	1.0000	0.0907	100.00%	4.7164		
			part weight	0.0907				
		Totals:		0.0907		90.70	100.00%	1000000

RoHS exemption claimed for lead in glass of electronic component